

3NM80

Power MOSFET

3A, 800V N-CHANNEL SUPER-JUNCTION MOSFET

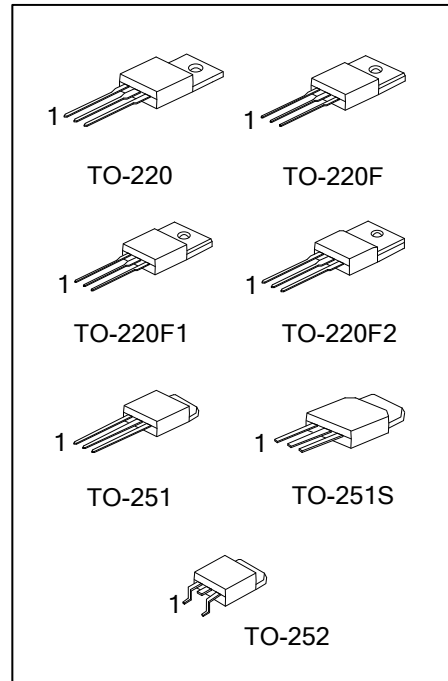
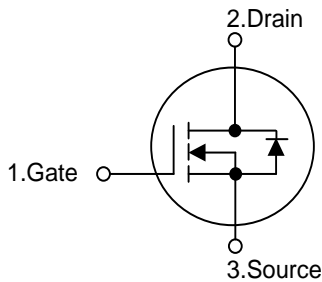
DESCRIPTION

The UTC 3NM80 is a Super Junction MOSFET Structure and is designed to have better characteristics, such as fast switching time, low gate charge, low on-state resistance and a high rugged avalanche characteristics. This power MOSFET is usually used at AC-DC converters for power applications.

FEATURES

- * $R_{DS(ON)} \leq 2.88 \Omega @ V_{GS} = 10V, I_D = 1.5A$
- * Fast switching capability
- * Avalanche energy tested
- * Improved dv/dt capability, high ruggedness

SYMBOL



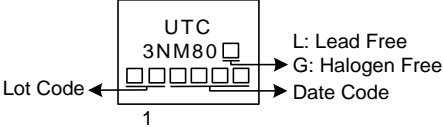
ORDERING INFORMATION

| Ordering Number | | Package | Pin Assignment | | | Packing |
|-----------------|--------------|----------|----------------|---|---|-----------|
| Lead Free | Halogen Free | | 1 | 2 | 3 | |
| 3NM80L-TA3-T | 3NM80G-TA3-T | TO-220 | G | D | S | Tube |
| 3NM80L-TF3-T | 3NM80G-TF3-T | TO-220F | G | D | S | Tube |
| 3NM80L-TF1-T | 3NM80G-TF1-T | TO-220F1 | G | D | S | Tube |
| 3NM80L-TF2-T | 3NM80G-TF2-T | TO-220F2 | G | D | S | Tube |
| 3NM80L-TM3-T | 3NM80G-TM3-T | TO-251 | G | D | S | Tube |
| 3NM80L-TMS-T | 3NM80G-TMS-T | TO-251S | G | D | S | Tube |
| 3NM80L-TN3-R | 3NM80G-TN3-R | TO-252 | G | D | S | Tape Reel |

Note: Pin Assignment: G: Gate D: Drain S: Source

| | |
|--|---|
| <p>3NM80G-TA3-T</p> <p>(1) Packing Type (2) Package Type (3) Green Package</p> | <p>(1) T: Tube, R: Tape Reel (2) TA3: TO-220, TF1: TO-220F1, TF2: TO-220F2 TF3: TO-220F, TM3: TO-251, TMS: TO-251S, TN3: TO-252 (3) G: Halogen Free and Lead Free, L: Lead Free</p> |
|--|---|

■ MARKING



■ ABSOLUTE MAXIMUM RATINGS ($T_C = 25^\circ\text{C}$, unless otherwise specified)

| PARAMETER | | SYMBOL | RATINGS | UNIT |
|------------------------------------|--------------------------|-----------|------------|------------------|
| Drain-Source Voltage | | V_{DSS} | 800 | V |
| Gate-Source Voltage | | V_{GSS} | ± 30 | V |
| Drain Current | Continuous | I_D | 3 | A |
| | Pulsed (Note 2) | I_{DM} | 12 | A |
| Avalanche Current (Note 2) | | I_{AR} | 1.4 | A |
| Avalanche Energy | | E_{AS} | 156 | mJ |
| Peak Diode Recovery dv/dt (Note 4) | | dv/dt | 3.5 | V/ns |
| Power Dissipation | TO-220 | P_D | 35 | W |
| | TO-220F/TO-220F1 | | 20 | W |
| | TO-220F2 | | | |
| | TO-251/TO-251S TO-252 | | 21 | W |
| Junction Temperature | | T_J | +150 | $^\circ\text{C}$ |
| Storage Temperature | | T_{STG} | -55 ~ +150 | $^\circ\text{C}$ |

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged.

Absolute maximum ratings are stress ratings only and functional device operation is not implied.

2. Repetitive Rating: Pulse width limited by maximum junction temperature.

3. $L=159\text{mH}$, $I_{AS}=1.4\text{A}$, $V_{DD}=50\text{V}$, $R_G=25\ \Omega$, Starting $T_J = 25^\circ\text{C}$

4. $I_{SD}\leq 3.0\text{A}$, $di/dt\leq 200\text{A}/\mu\text{s}$, $V_{DD}\leq BV_{DSS}$, Starting $T_J = 25^\circ\text{C}$

■ THERMAL DATA

| PARAMETER | | SYMBOL | RATING | UNIT |
|---------------------|-------------------------------------|---------------|-------------|---------------------------|
| Junction to Ambient | TO-220/TO-220F TO-220F1/TO-220F2 | θ_{JA} | 62.5 | $^\circ\text{C}/\text{W}$ |
| | TO-251/TO-251S TO-252 | | 110 | $^\circ\text{C}/\text{W}$ |
| Junction to Case | TO-220 | θ_{JC} | 3.57 | $^\circ\text{C}/\text{W}$ |
| | TO-220F/TO-220F1 TO-220F2 | | 6.25 | $^\circ\text{C}/\text{W}$ |
| | TO-251/TO-251S TO-252 | | 5.95 (Note) | $^\circ\text{C}/\text{W}$ |

Note: Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.

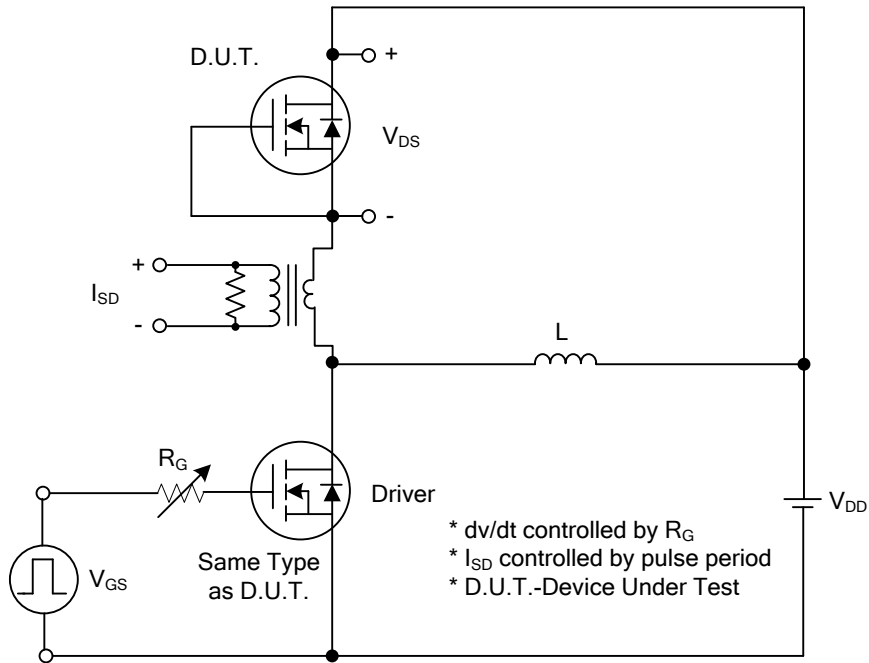
■ **ELECTRICAL CHARACTERISTICS** ($T_J=25^\circ\text{C}$, unless otherwise specified)

| PARAMETER | SYMBOL | TEST CONDITIONS | MIN | TYP | MAX | UNIT |
|--|--------------|--|-----|------|------|----------|
| OFF CHARACTERISTICS | | | | | | |
| Drain-Source Breakdown Voltage | BV_{DSS} | $V_{GS} = 0V, I_D = 250\mu A$ | 800 | | | V |
| Drain-Source Leakage Current | I_{DSS} | $V_{DS} = 800V, V_{GS} = 0V$ | | | 10 | μA |
| Gate-Source Leakage Current | I_{GSS} | $V_{GS} = 30V, V_{DS} = 0V$ | | | 100 | nA |
| | | $V_{GS} = -30V, V_{DS} = 0V$ | | | -100 | nA |
| ON CHARACTERISTICS | | | | | | |
| Gate Threshold Voltage | $V_{GS(TH)}$ | $V_{DS} = V_{GS}, I_D = 250\mu A$ | 2.5 | | 4.5 | V |
| Static Drain-Source On-State Resistance | $R_{DS(ON)}$ | $V_{GS} = 10V, I_D = 1.5A$ | | | 2.88 | Ω |
| DYNAMIC CHARACTERISTICS | | | | | | |
| Input Capacitance | C_{ISS} | $V_{GS}=0V, V_{DS}=25V, f=1.0MHz$ | | 260 | | pF |
| Output Capacitance | C_{OSS} | | | 110 | | pF |
| Reverse Transfer Capacitance | C_{RSS} | | | 9 | | pF |
| SWITCHING CHARACTERISTICS | | | | | | |
| Total Gate Charge (Note 1) | Q_G | $V_{DS}=50V, I_D=1.3A, I_G=100\mu A$ $V_{GS}=10V$ (Note 1,2) | | 36 | | nC |
| Gate to Source Charge | Q_{GS} | | | 4 | | nC |
| Gate to Drain Charge | Q_{GD} | | | 7 | | nC |
| Turn-ON Delay Time (Note 1) | $t_{D(ON)}$ | $V_{DD}=30V, I_D=0.5A, R_G=25\Omega,$ $V_{GS}=10V$ (Note 1,2) | | 32 | | nS |
| Rise Time | t_R | | | 48 | | nS |
| Turn-OFF Delay Time | $t_{D(OFF)}$ | | | 105 | | nS |
| Fall-Time | t_F | | | 28 | | nS |
| SOURCE- DRAIN DIODE RATINGS AND CHARACTERISTICS | | | | | | |
| Maximum Body-Diode Continuous Current | I_S | | | | 3 | A |
| Maximum Body-Diode Pulsed Current | I_{SM} | | | | 12 | A |
| Drain-Source Diode Forward Voltage (Note 1) | V_{SD} | $I_S=3.0A, V_{GS}=0V$ | | | 1.4 | V |
| Body Diode Reverse Recovery Time (Note 1) | t_{rr} | $I_S=3.0A, V_{GS}=0V$ | | 330 | | nS |
| Body Diode Reverse Recovery Charge | Q_{rr} | $dI_F/dt=100A/\mu s$ | | 2.15 | | μC |

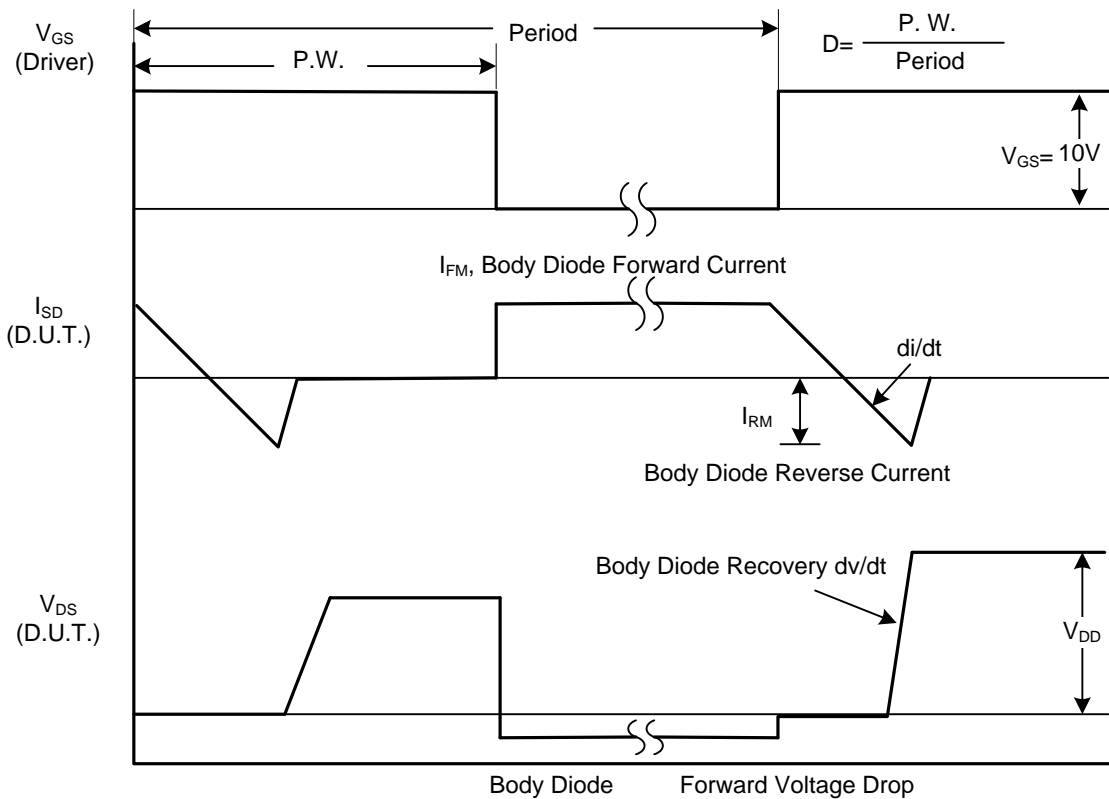
Notes: 1. Pulse Test : Pulse width $\leq 300\mu s$, Duty cycle $\leq 2\%$.

2. Essentially independent of operating ambient temperature.

■ TEST CIRCUITS AND WAVEFORMS

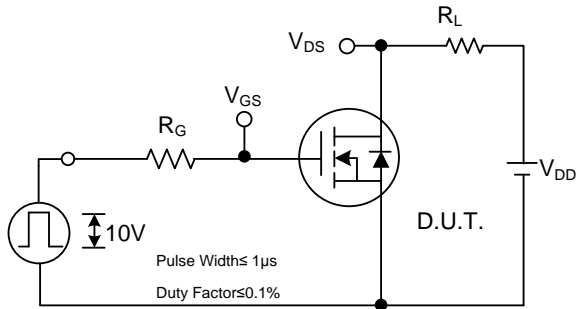


Peak Diode Recovery dv/dt Test Circuit

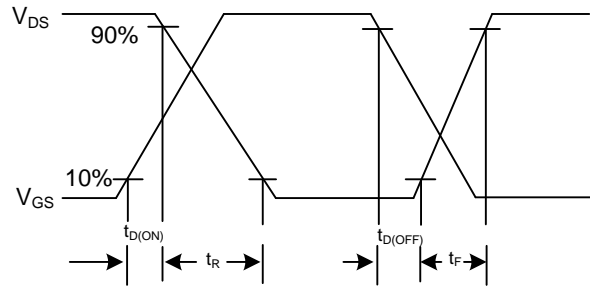


Peak Diode Recovery dv/dt Waveforms

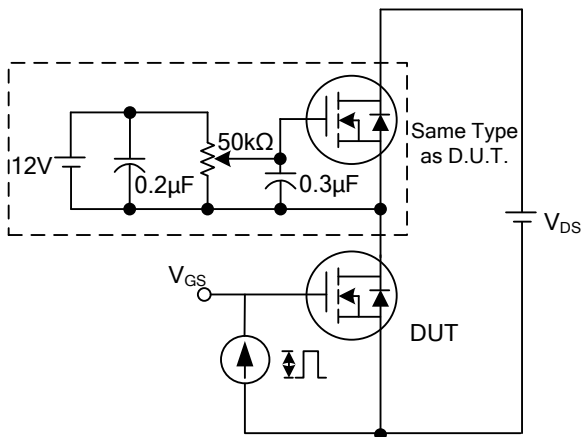
TEST CIRCUITS AND WAVEFORMS



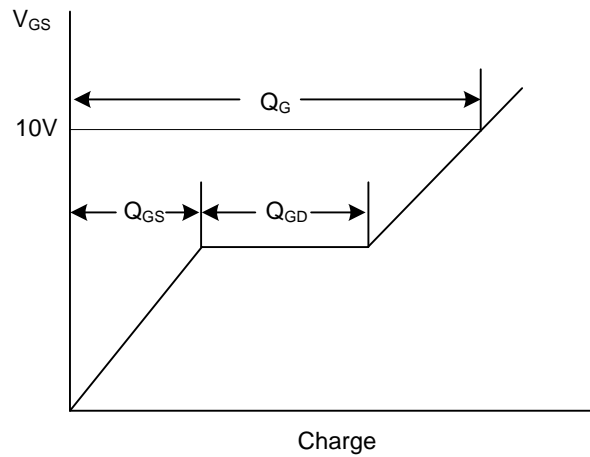
Switching Test Circuit



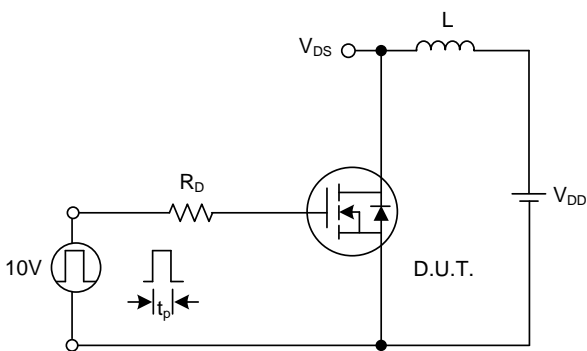
Switching Waveforms



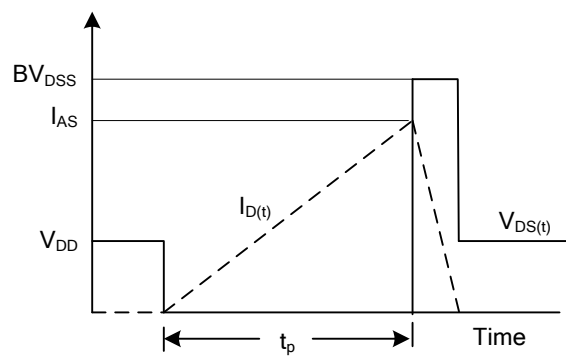
Gate Charge Test Circuit



Gate Charge Waveform



Unclamped Inductive Switching Test Circuit



Unclamped Inductive Switching Waveforms

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